

# 2MBI300UE-120

## IGBT Module U-Series 1200V / 300A 2 in one-package

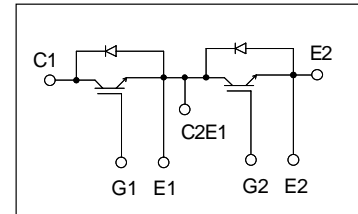
### ■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

### ■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

### ■ Equivalent Circuit Schematic



### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Conditions	Rating	Unit	
Collector-Emitter voltage	$V_{CES}$		1200	V	
Gate-Emitter voltage	$V_{GES}$		$\pm 20$	V	
Collector current	$I_c$	Continuous	$T_c=25^\circ\text{C}$	450	A
			$T_c=80^\circ\text{C}$	300	
	$I_{cp}$	1ms	$T_c=25^\circ\text{C}$	900	
			$T_c=80^\circ\text{C}$	600	
	$-I_c$			300	
$-I_c$ pulse			600		
Collector Power Dissipation	$P_c$	1 device	1660	W	
Junction temperature	$T_j$		+150	$^\circ\text{C}$	
Storage temperature	$T_{stg}$		-40 to +125		
Isolation voltage   between terminal and copper base *1	$V_{iso}$	AC:1min.	2500	VAC	
Screw Torque	Mounting *2		3.5	N·m	
	Terminals *2		4.5		

\*1: All terminals should be connected together when isolation test will be done.

\*2: Recommendable value : Mounting 2.5 to 3.5 N·m(M5 or M6), Terminals 3.5 to 4.5N·m(M6)

#### ● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

Item	Symbols	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Zero gate voltage collector current	$I_{CES}$	$V_{GE}=0V, V_{CE}=1200V$	–	–	3.0	mA	
Gate-Emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=\pm 20V$	–	–	600	nA	
Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=20V, I_c=300mA$	4.5	6.5	8.5	V	
Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE}=15V, I_c=300A$	$T_j=25^\circ\text{C}$	–	1.95	2.30	V
			$T_j=125^\circ\text{C}$	–	2.20	–	
	$V_{CE(sat)}$ (chip)		$T_j=25^\circ\text{C}$	–	1.75	2.10	
			$T_j=125^\circ\text{C}$	–	2.00	–	
Input capacitance	$C_{ies}$	$V_{CE}=10V, V_{GE}=0V, f=1MHz$	–	34	–	nF	
Turn-on time	$t_{on}$	$V_{CC}=600V$	–	0.36	1.20	$\mu\text{s}$	
	$t_r$	$I_c=300A$	–	0.21	0.60		
	$t_{r(j)}$	$V_{GE}=\pm 15V$	–	0.03	–		
Turn-off time	$t_{off}$	$R_G=2.0\ \Omega$	–	0.37	1.00		
	$t_f$		–	0.07	0.30		
Forward on voltage	$V_F$ (terminal)	$V_{GE}=0V, I_F=300A$	$T_j=25^\circ\text{C}$	–	1.75	2.05	V
			$T_j=125^\circ\text{C}$	–	1.85	–	
	$V_F$ (chip)		$T_j=25^\circ\text{C}$	–	1.60	1.90	
			$T_j=125^\circ\text{C}$	–	1.70	–	
Reverse recovery time	$t_{rr}$	$I_F=300A$	–	–	0.35	$\mu\text{s}$	
Lead resistance, terminal-chip*3	R lead		–	0.45	–	m $\Omega$	

\*3:Biggest internal terminal resistance among arm.

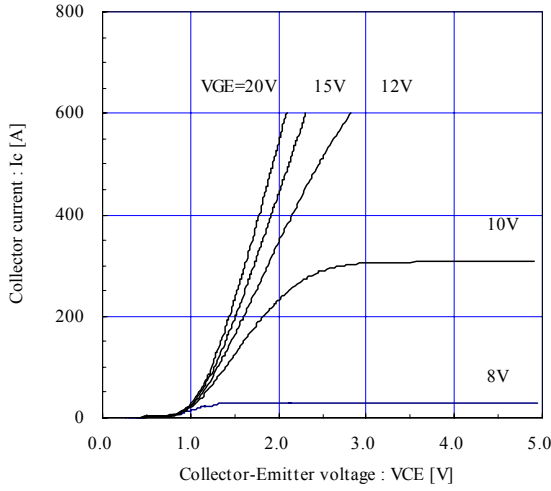
#### ● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th(j-c)}$	IGBT	–	–	0.075	$^\circ\text{C/W}$
	$R_{th(j-c)}$	FWD	–	–	0.12	$^\circ\text{C/W}$
Contact Thermal resistance	$R_{th(c-f)}$ *4	With thermal compound	–	0.0167	–	$^\circ\text{C/W}$

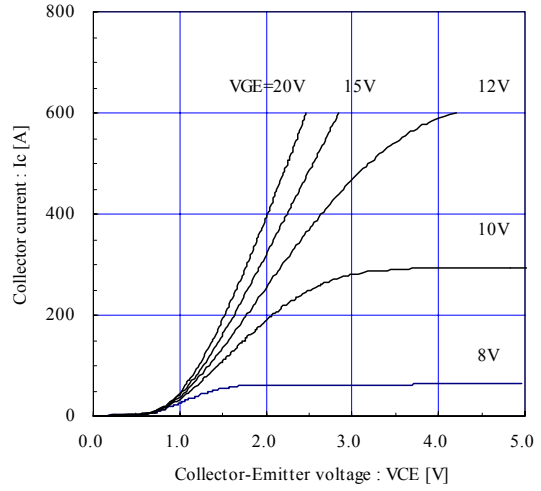
\*4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

Characteristics (Representative)

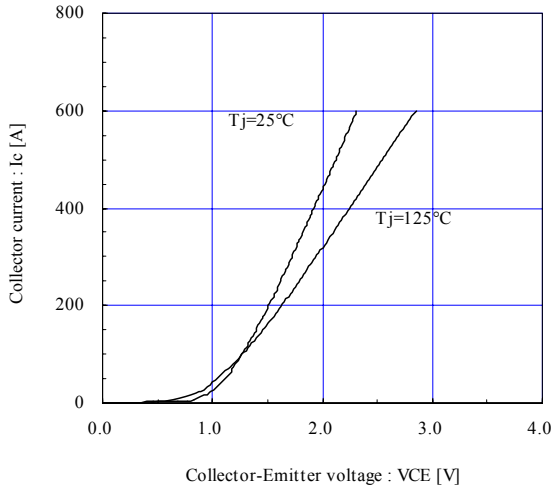
Collector current vs. Collector-Emitter voltage (typ.)  
Tj= 25°C / chip



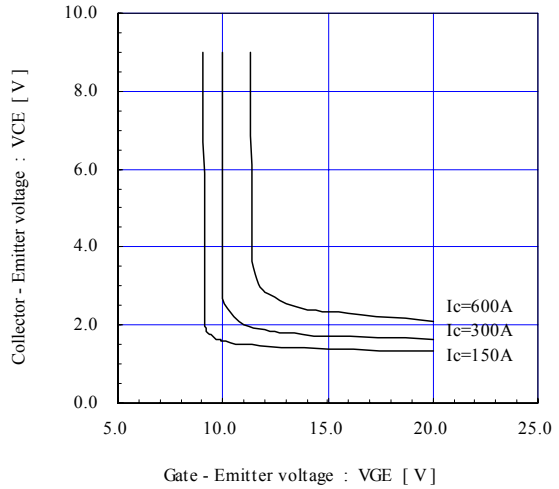
Collector current vs. Collector-Emitter voltage (typ.)  
Tj= 125°C / chip



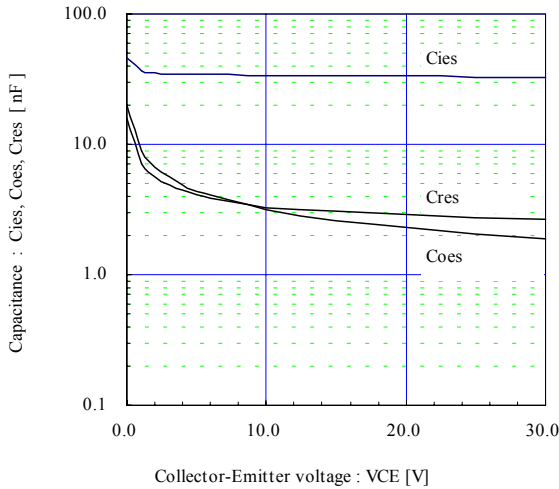
Collector current vs. Collector-Emitter voltage (typ.)  
VGE=15V / chip



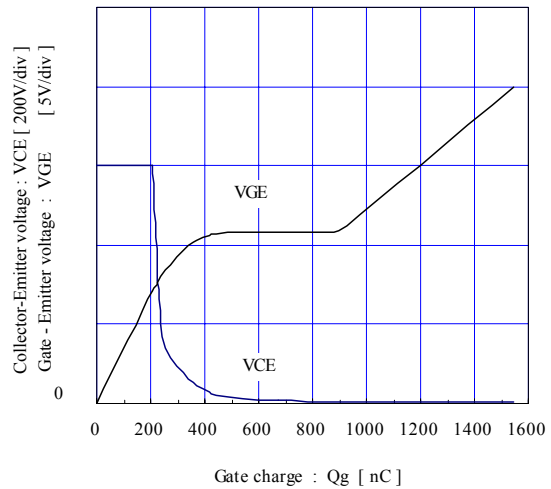
Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)  
Tj=25°C / chip



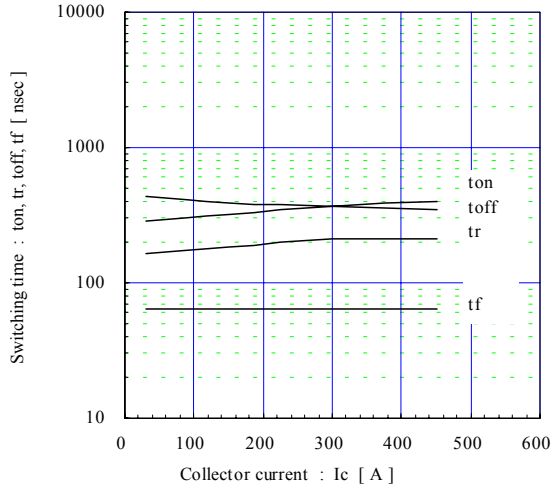
Capacitance vs. Collector-Emitter voltage (typ.)  
VGE=0V, f= 1MHz, Tj= 25°C



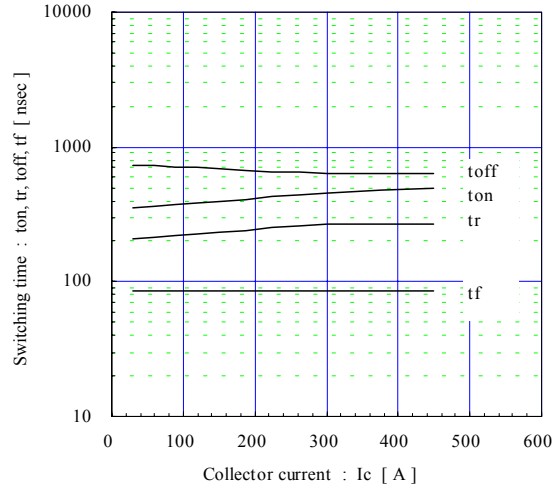
Dynamic Gate charge (typ.)  
Vcc=600V, Ic=300A, Tj= 25°C



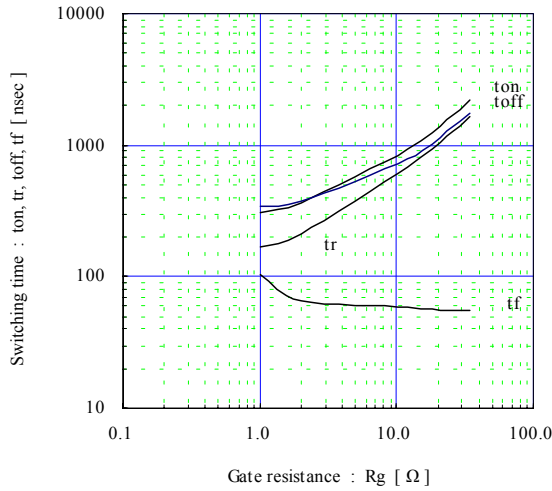
Switching time vs. Collector current (typ.)  
 $V_{cc}=600V, V_{GE}=\pm 15V, R_g=2\Omega, T_j=25^\circ C$



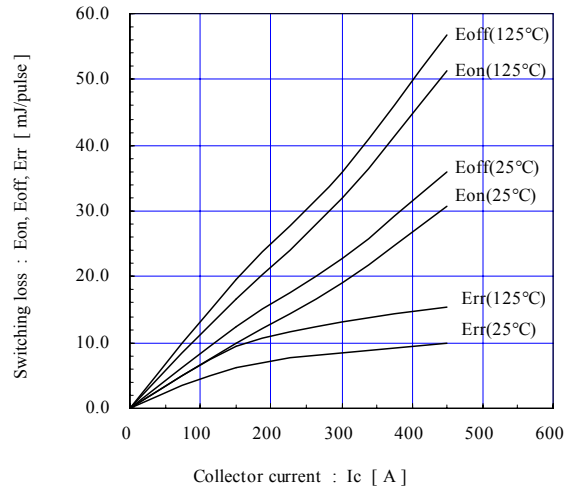
Switching time vs. Collector current (typ.)  
 $V_{cc}=600V, V_{GE}=\pm 15V, R_g=2\Omega, T_j=125^\circ C$



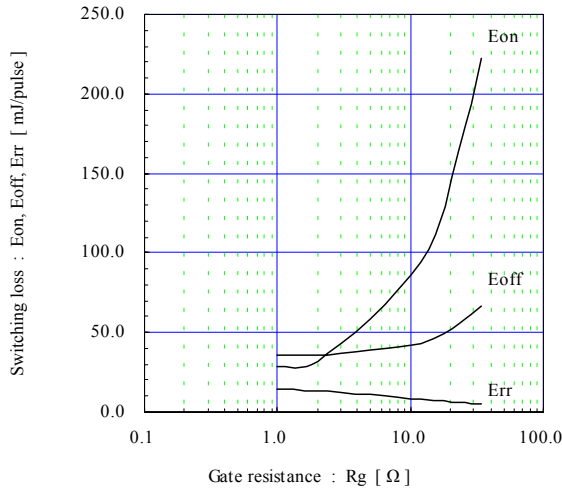
Switching time vs. Gate resistance (typ.)  
 $V_{cc}=600V, I_c=300A, V_{GE}=\pm 15V, T_j=25^\circ C$



Switching loss vs. Collector current (typ.)  
 $V_{cc}=600V, V_{GE}=\pm 15V, R_g=2\Omega$



Switching loss vs. Gate resistance (typ.)  
 $V_{cc}=600V, I_c=300A, V_{GE}=\pm 15V, T_j=125^\circ C$



Reverse bias safe operating area (max.)  
 $+V_{GE}=15V, -V_{GE} \le 15V, R_g \ge 2\Omega, T_j \le 125^\circ C$

